

PACKAGE DIMENSIONS SUPER RED **MV811X** MV8111 MV8112 0.200 (5.08) 0.180 (4.57) 5°-MV8113 MV8114 0.350 (8.89) 0.040 (1.02) 0.330 (8.38) **FEATURES** • Popular T-1 3/4 package 1.00 (25.4) · Super high brightness suitable for outdoor MIN applications · Solid state reliability Water clear optics 0.023 (0.58) 0.017 (0.43) SQ. (2X) 0.050 (1.27) · Standard 100 mil. lead spacing NOM 0.100 (2.54) NOM FLAT DENOTES CATHODE п Ø0.230 (5.84) NOTES: DESCRIPTION

- 1. Dimensions for all drawings are in inches (mm).
- 2. Lead spacing is measured where the leads emerge from the package.
- 3. Protruded resin under the flange is 1.5 mm (0.059") max.

This T-1 3/4 super bright LED has a narrow viewing angle of 12° for concentrated light output. The MV811X series is made with an AlGaAs LED that emits red light at 660 nm. It is encapsulated in a water clear epoxy lens package.

ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise specified)							
Parameter	Symbol	Rating	Unit				
Operating Temperature	T _{OPR}	-40 to +100	°C				
Storage Temperature	T _{STG}	-40 to +100	°C				
Lead Soldering Time	T _{SOL}	260 for 5 sec	°C				
Continuous Forward Current	I _F	30	mA				
Peak Forward Current (f = 1.0 KHz, Duty Factor = 1/10)	I _F	200	mA				
Reverse Voltage	V _R	5	V				
Power Dissipation	PD	100	mW				



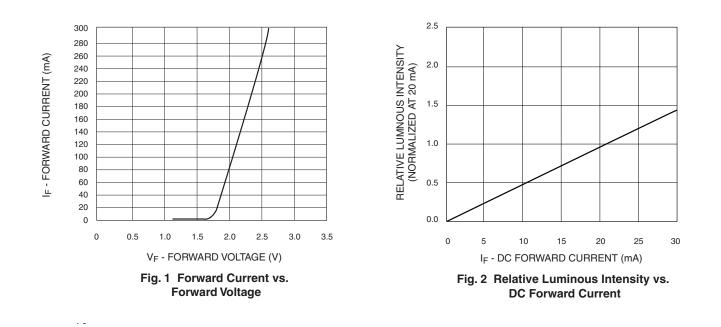
 SUPER RED
 MV811X

 MV8111
 MV8112

 MV8113
 MV8114

ELECTRICAL / OPTICAL CHARACTERISTICS (TA =25°C)							
Part Number	MV8111	MV8112	MV8113	MV8114	Condition		
Luminous Intensity (mcd)					$I_F = 20 \text{mA}$		
Minimum	250	630	1000	1600			
Typical	370	940	1500	2400			
Forward Voltage (V)					$I_F = 20mA$		
Maximum	2.4	2.4	2.4	2.4			
Typical	1.7	1.7	1.7	1.7			
Peak Wavelength (nm)	660	660	660	660	$I_F = 20 \text{mA}$		
Spectral Line Half Width (nm)	20	20	20	20	$I_F = 20 mA$		
Viewing Angle (°)	12	12	12	12	$I_F = 20mA$		

TYPICAL PERFORMANCE CURVES





 SUPER RED
 MV811X

 MV8111
 MV8112

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 MV8114

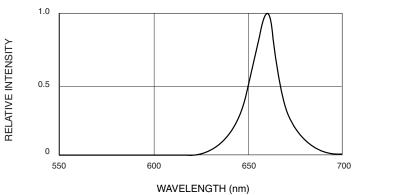


Fig. 3 Relative Intensity vs. Peak Wavelength

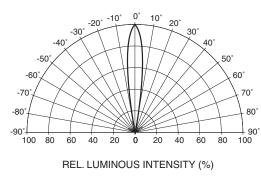
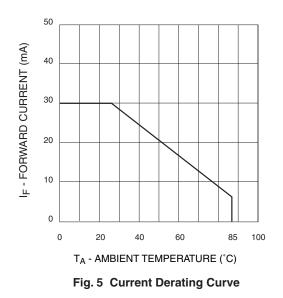


Fig. 4 Radiation Diagram





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